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NC7WP14

TinyLogic→ **ULP Dual Inverter** with Schmitt Trigger Inputs

General Description

The NC7WP14 is a dual inverter with Schmitt trigger inputs from Fairchild's Ultra Low Power (ULP) Series of TinyLogic -. Ideal for applications where battery life is critical, this product is designed for ultra low power consumption within the V_{CC} operating range of 0.9V to 3.6V V_{CC} .

The internal circuit is composed of a minimum of inverter stages, including the output buffer, to enable ultra low static and dynamic power.

The NC7WP14, for lower drive requirements, is uniquely designed for optimized power and speed, and is fabricated with an advanced CMOS technology to achieve best in class speed operation while maintaining extremely low CMOS power dissipation.

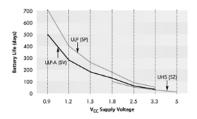
Features

- 0.9V to 3.6V V_{CC} supply operation
- 3.6V overvoltage tolerant I/O's at V_{CC} from 0.9V to 3.6V
- t_{PD}
 - 4.0 ns typ for 3.0V to 3.6V $\ensuremath{\text{V}_{\text{CC}}}$
 - 5.0 ns typ for 2.3V to 2.7V V_{CC}
 - 6.0 ns typ for 1.65V to 1.95V V_{CC}
 - 7.0 ns typ for 1.40V to 1.60V V_{CC}
 - 11.0 ns typ for 1.10V to 1.30V V_{CC}
 - 27.0 ns typ for 0.90V V_{CC}
- Power-Off high impedance inputs and outputs
- Static Drive (I_{OH}/I_{OL})
 - ±2.6 mA @ 3.00V V_{CC}
 - ±2.1 mA @ 2.30V V_{CC}
 - ±1.5 mA @ 1.65V V_{CC}
 - ±1.0 mA @ 1.40V V_{CC}
 - ±0.5 mA @ 1.10V V_{CC}
 - ±20 xA @ 0.9V VCC
- Uses patented Quiet Series[™] noise/EMI reduction
- Ultra small MicroPak™ leadfree package
- Ultra low dynamic power

Ordering Code:

Order Number	r Number Package Product Code Number Top Mark		Package Description	Supplied As
NC7WP14P6X	MAA06A	P14	6-Lead SC70, EIAJ SC88, 1.25mm Wide	3k Units on Tape and Reel
NC7WP14L6X	MAC06A	AZ	6-Lead MicroPak, 1.0mm Wide	5k Units on Tape and Reel

Battery Life vs. V_{CC} Supply Voltage



TinyLogic ULP and ULP-A with up to 50% less power consumption can extend your battery life significantly.

Battery Life = $(V_{battery} *I_{battery} *.9)/(P_{device})/24hrs/day$

Where, P_{device} = $(I_{CC} * V_{CC}) + (C_{PD} + C_L) * V_{CC}^2 * f$ Assumes ideal 3.6V Lithium Ion battery with current rating of 900mAH and derated 90% and device frequency at 10MHz, with CL = 15 pF load

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Logic Symbol

IEEE/IEC



Pin Descriptions

Pin Names	Description
A ₁ , A ₂	Data Inputs
Y ₁ , Y ₂	Output

Function Table

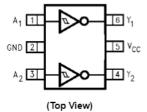
 $Y=\overline{\boldsymbol{A}}$

Inputs	Output
Α	Y
L	Н
Н	L

H = HIGH Logic Level L = LOW Logic Level

Connection Diagrams

Pin Assignments for SC70



Pin One Orientation Diagram

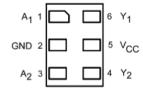


Pin One

AAA represents Product Code Top Mark - see ordering code

Note: Orientation of Top Mark determines Pin One location. Read the top
product code mark left to right, Pin One is the lower left pin (see diagram).

Pad Assignments for MicroPak



(Top Thru View)

Absolute Maximum Ratings(Note 1)

Supply Voltage (V_{CC}) -0.5V to +4.6V

DC Input Diode Current (I_{IK}) V_{IN} < 0V DC Output Diode Current (I_{OK})

 $\begin{array}{lll} V_{OUT} < 0V & -50 \text{ mA} \\ V_{OUT} > V_{CC} & +50 \text{ mA} \\ \text{DC Output Source/Sink Current (I}_{OH}/I_{OL}) & \pm 50 \text{ mA} \\ \end{array}$

DC V_{CC} or Ground Current per Supply Pin (I_{CC} or Ground)

Storage Temperature Range (T_{STG}) -65°C to +150°C

Recommended Operating Conditions (Note 3)

 $\begin{array}{ccc} -0.5 \text{V to } +4.6 \text{V} & \text{Supply Voltage} & 0.9 \text{V to } 3.6 \text{V} \\ & \text{Input Voltage (V}_{\text{IN}}) & 0.0 \text{V to } 3.6 \text{V} \end{array}$

Output Voltage (V_{OUT})

±50 mA

± 50 mA

HIGH or LOW State $V_{CC} = 0V$ 0V to V_{CC}

Output Current in I_{OH}/I_{OL}

 V_{CC} = 0.9V $\pm 20 \text{ } \text{mA}$ Free Air Operating Temperature (T_A) -40°C to $+85^{\circ}\text{C}$

Minimum Input Edge Rate (Δt/ΔV)

 $V_{IN} = 0.8V \text{ to } 2.0V, V_{CC} = 3.0V$ 10 ns/V

Note 1: Absolute Maximum Ratings: are those values beyond which the safety of the device cannot be guaranteed. The device should not be operated at these limits. The parametric values defined in the Electrical Characteristics tables are not guaranteed at the absolute maximum ratings. The "Recommended Operating Conditions" table will define the conditions for actual device operation.

Note 2: IO Absolute Maximum Rating must be observed.

Note 3: Unused inputs must be held HIGH or LOW. They may not float.

DC Electrical Characteristics

Symbol	Parameter	V _{cc}	T _A =	+ 2 5°C	$T_A = -40^{\circ}\text{C to } +85^{\circ}\text{C}$		Units	Conditions
Symbol	Farameter	(V)	Min	Max	Min	Max	Oilles	Conditions
V _P	Positive Threshold Voltage	0.90	0.35	0.65	0.35	0.65		
		1.10	0.4	1.0	0.4	1.0		
		1.40	0.5	1.2	0.5	1.2	l _v l	
		1.65	0.7	1.5	0.7	1.5	V	
		2.30	1.0	1.9	1.0	1.9		
		3.00	1.5	2.6	1.5	2.6		
V _N	Negative Threshold Voltage	0.90	0.1	0.6	0.1	0.6		
		1.10	0.15	0.7	0.15	0.7		
		1.40	0.2	8.0	0.2	8.0	l v l	
		1.65	0.25	0.9	0.25	0.9		
		2.30	0.4	1.15	0.4	1.15		
		3.00	0.6	1.5	0.6	1.5		
V _H	Hysteresis Voltage	0.90	0.07	0.5	0.07	0.5		
		1.10	0.08	0.6	0.08	0.6		
		1.40	0.09	8.0	0.09	8.0	l v l	
		1.65	0.10	1.0	0.10	1.0		
		2.30	0.25	1.1	0.25	1.1		
		3.00	0.60	1.8	0.60	1.8		

DC Electrical Characteristics (Continued)

Symbol	Parameter	V _{cc}	T _A = +	2 5°C	T _A = -40°C to +85°C		Units	Conditions
Symbol	Parameter	(V)	Min	Max	Min	Max	Units	Conditions
V _{OH}	HIGH Level	0.90	V _{CC} - 0.1		V _{CC} - 0.1			
	Output Voltage	1.10 ≤ V _{CC} ≤ 1.30	V _{CC} - 0.1		V _{CC} - 0.1			
		1.40 ≤ V _{CC} ≤ 1.60	V _{CC} - 0.1		V _{CC} - 0.1			I _{OH} = -20 ∞A
		1.65 ≤ V _{CC} ≤ 1.95	V _{CC} - 0.1		V _{CC} - 0.1			10H - 20 WA
		2.30 ≤ V _{CC} ≤ 2.70	V _{CC} - 0.1		V _{CC} - 0.1			
		3.00 ≤ V _{CC} ≤ 3.60	V _{CC} - 0.1		V _{CC} - 0.1		V	
		1.10 ≤ V _{CC} ≤ 1.30	0.75 x V _{CC}		0.70 x V _{CC}			$I_{OH} = -0.5 \text{ mA}$
		1.40 ≤ V _{CC} ≤ 1.60	1.07		0.99			I _{OH} = -1 mA
		1.65 ≤ V _{CC} ≤ 1.95	1.24		1.22			I _{OH} = -1.5 mA
		2.30 ≤ V _{CC} ≤ 2.70	1.95		1.87			I _{OH} = -2.1 mA
		3.00 ≤ V _{CC} ≤ 3.60	2.61		2.55			I _{OH} = -2.6 mA
V _{OL}	LOW Level	0.90		0.1		0.1		
	Output Voltage	1.10 ≤ V _{CC} ≤ 1.30		0.1		0.1		
		1.40 ≤ V _{CC} ≤ 1.60		0.1		0.1		I _{OL} = 20 ∞A
		1.65 ≤ V _{CC} ≤ 1.95		0.1		0.1		10L - 20 WA
		2.30 ≤ V _{CC} ≤ 2.70		0.1		0.1		
		3.00 ≤ V _{CC} ≤ 3.60		0.1		0.1	V	
		1.10 ≤ V _{CC} ≤ 1.30		0.30 x V _{CC}		0.30 x V _{CC}		$I_{OL} = 0.5 \text{ mA}$
		1.40 ≤ V _{CC} ≤ 1.60		0.31		0.37		I _{OL} = 1 mA
		1.65 ≤ V _{CC} ≤ 1.95		0.31		0.35		I _{OL} = 1.5 mA
		2.30 ≤ V _{CC} ≤ 2.70		0.31		0.33		I _{OL} = 2.1 mA
		3.00 ≤ V _{CC} ≤ 3.60		0.31		0.33		I _{OL} = 2.6 mA
I _{IN}	Input Leakage Current	0.90 to 3.60		±0.1		±0.5	œΑ	0 ≤ V ₁ ≤ 3.6V
I _{OFF}	Power Off Leakage Current	0		0.5		0.5	œΑ	$0 \le (V_1, V_0) \le 3.6V$
Icc	Quiescent Supply Current	0.90 to 3.60		0.9		0.9	œΑ	V _I = V _{CC} or GND

AC Electrical Characteristics

ation Delay	(V) 0.90 1.10 $\le V_{CC} \le 1.30$ 1.40 $\le V_{CC} \le 1.60$ 1.65 $\le V_{CC} \le 1.95$ 2.30 $\le V_{CC} \le 2.70$ 3.00 $\le V_{CC} \le 3.60$ 0.90 1.10 $\le V_{CC} \le 1.30$ 1.40 $\le V_{CC} \le 1.60$	2.5 2.0 1.5 1.0	Typ 27 11 7 6 5 4 30	26.8 15.8 12.0 9.4 8.3	3.0 2.0 1.5 1.0	37.3 16.0 12.2 9.9 9.0	Units	Conditions $C_L = 10 \text{ pF}$ $R_L = 1 \text{ M}\Omega$	Figure Number Figures 1, 2
ation Delay	$\begin{array}{c} 1.10 \le V_{CC} \le 1.30 \\ 1.40 \le V_{CC} \le 1.60 \\ 1.65 \le V_{CC} \le 1.95 \\ 2.30 \le V_{CC} \le 2.70 \\ 3.00 \le V_{CC} \le 3.60 \\ \hline 0.90 \\ 1.10 \le V_{CC} \le 1.30 \end{array}$	2.5 2.0 1.5 1.0	11 7 6 5 4	15.8 12.0 9.4	2.0 1.5 1.0	16.0 12.2 9.9	ns	I .	Figures 1, 2
ation Delay	$\begin{array}{c} 1.40 \le V_{CC} \le 1.60 \\ 1.65 \le V_{CC} \le 1.95 \\ 2.30 \le V_{CC} \le 2.70 \\ 3.00 \le V_{CC} \le 3.60 \\ \hline 0.90 \\ 1.10 \le V_{CC} \le 1.30 \\ \end{array}$	2.5 2.0 1.5 1.0	7 6 5 4 30	15.8 12.0 9.4	2.0 1.5 1.0	16.0 12.2 9.9	ns	I .	Figures 1, 2
ation Delay	$1.65 \le V_{CC} \le 1.95$ $2.30 \le V_{CC} \le 2.70$ $3.00 \le V_{CC} \le 3.60$ 0.90 $1.10 \le V_{CC} \le 1.30$	2.0 1.5 1.0	6 5 4 30	12.0 9.4	1.5 1.0	12.2 9.9	ns	I .	Figures 1, 2
ation Delay	2.30 \(\leq V_{CC} \leq 2.70\) 3.00 \(\leq V_{CC} \leq 3.60\) 0.90 1.10 \(\leq V_{CC} \leq 1.30\)	1.5 1.0	5 4 30	9.4	1.0	9.9	115	R _L = 1 MΩ	1, 2
ation Delay	$3.00 \le V_{CC} \le 3.60$ 0.90 $1.10 \le V_{CC} \le 1.30$	1.0	4 30						
ation Delay	0.90 1.10 ≤ V _{CC} ≤ 1.30		30	8.3	1.0	9.0			
-	1.10 ≤ V _{CC} ≤ 1.30	4.0							
		4.0							
	140 - 1/ - 160		11	29.8	3.5	39.3			
	1.40 2 VCC 2 1.00	3.0	8	16.5	2.5	17.5	ns	C _L = 15 pF	Figures 1, 2
	1.65 ≤ V _{CC} ≤ 1.95	2.5	6	12.6	2.0	13.6	115	$R_L = 1 M\Omega$	1, 2
	2.30 ≤ V _{CC} ≤ 2.70	2.0	5	9.9	1.5	10.8			
	$3.00 \le V_{CC} \le 3.60$	1.5	4	8.7	1.0	9.5			
ation Delay	0.90		32						
	1.10 ≤ V _{CC} ≤ 1.30	5.0	13	32.5	4.0	48.3			Figures 1, 2
	1.40 ≤ V _{CC} ≤ 1.60	4.0	9	18.8	3.5	19.2	ne	C _L = 30 pF	
	1.65 ≤ V _{CC} ≤ 1.95	3.0	7	14.4	2.0	15.9	115	$R_L = 1 M\Omega$	
	2.30 ≤ V _{CC} ≤ 2.70	2.0	6	11.3	1.5	12.8			
	$3.00 \le V_{CC} \le 3.60$	1.5	5	9.2	1.0	10.7			
pacitance	0		2.0				pF		
Capacitance	0		4.0				pF		
Dissipation	0.9 to 3.60		8				pF	V _I = 0V or V _{CC} , f = 10 MHz	
a p	pacitance apacitance	$\begin{array}{c} 1.10 \le V_{\rm CC} \le 1.30 \\ 1.40 \le V_{\rm CC} \le 1.60 \\ 1.65 \le V_{\rm CC} \le 1.95 \\ 2.30 \le V_{\rm CC} \le 2.70 \\ 3.00 \le V_{\rm CC} \le 3.60 \\ \\ \\ \text{pacitance} \\ \\ 0 \ \\ \text{position} \\ \hline \\ 0 \ \\ \text{9 to 3 60} \\ \end{array}$	1.10 ≤ V _{CC} ≤ 1.30 5.0 1.40 ≤ V _{CC} ≤ 1.60 4.0 1.65 ≤ V _{CC} ≤ 1.95 3.0 2.30 ≤ V _{CC} ≤ 2.70 2.0 3.00 ≤ V _{CC} ≤ 3.60 1.5 pacitance 0 apacitance 0 ssipation 0.9 to 3.60	$\begin{array}{cccccccccccccccccccccccccccccccccccc$	$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	1.10 ≤ V _{CC} ≤ 1.30 5.0 13 32.5 4.0 1.40 ≤ V _{CC} ≤ 1.60 4.0 9 18.8 3.5 1.65 ≤ V _{CC} ≤ 1.95 3.0 7 14.4 2.0 2.30 ≤ V _{CC} ≤ 2.70 2.0 6 11.3 1.5 3.00 ≤ V _{CC} ≤ 3.60 1.5 5 9.2 1.0 pacitance 0 2.0 apacitance 0 4.0 ssipation 0.9 to 3.60 8	$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	1.10 ≤ V _{CC} ≤ 1.30 5.0 13 32.5 4.0 48.3 1.40 ≤ V _{CC} ≤ 1.60 4.0 9 18.8 3.5 19.2 1.65 ≤ V _{CC} ≤ 1.95 3.0 7 14.4 2.0 15.9 2.30 ≤ V _{CC} ≤ 2.70 2.0 6 11.3 1.5 12.8 3.00 ≤ V _{CC} ≤ 3.60 1.5 5 9.2 1.0 10.7 pc. acitance 0 2.0 pc. apacitance 0 4.0 pc. sispation 0.9 to 3.60 8	1.10 ≤ V _{CC} ≤ 1.30 5.0 13 32.5 4.0 48.3 1.40 ≤ V _{CC} ≤ 1.60 4.0 9 18.8 3.5 19.2 1.65 ≤ V _{CC} ≤ 1.95 3.0 7 14.4 2.0 15.9 2.30 ≤ V _{CC} ≤ 2.70 2.0 6 11.3 1.5 12.8 3.00 ≤ V _{CC} ≤ 3.60 1.5 5 9.2 1.0 10.7 PF apacitance 0 2.0 pF apacitance 0 4.0 pF v _C = 0 v

AC Loading and Waveforms

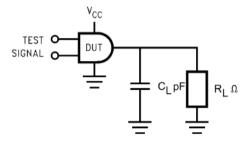


FIGURE 1. AC Test Circuit

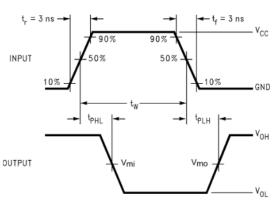


FIGURE 2. AC Waveforms

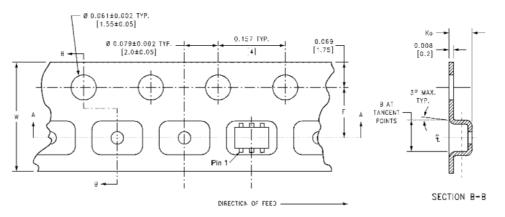
Symbol	V _{cc}							
- Symbol	3.3V ± 0.3V	2.5V ± 0.2V	1.8V ± 0.15V	1.5V ± 0.10V	1.2V ± 0.10V	0.9V		
V _{mi}	1.5V	V _{CC} /2						
V _{mo}	1.5V	V _{CC} /2						

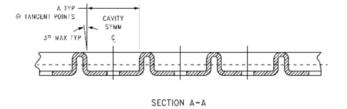
Tape and Reel Specification

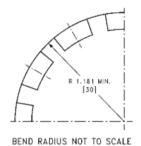
TAPE FORMAT for SC70

Package	Tape	Number	Cavity	Cover Tape	
Designator	Section	Cavities	Status	Status	
	Leader (Start End)	125 (typ)	Empty	Sealed	
P6X	Carrier	3000	Filled	Sealed	
	Trailer (Hub End)	75 (typ)	Empty	Sealed	

TAPE DIMENSIONS inches (millimeters)

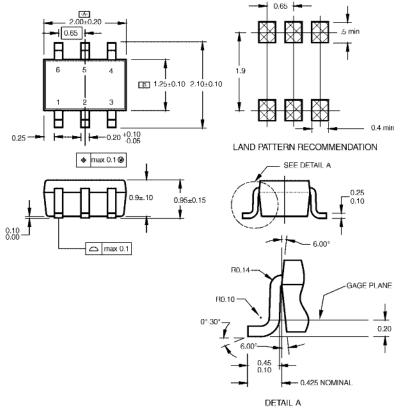






Tape and Reel Specification (Continued) TAPE FORMAT for MicroPak Package Tape Number Cavity Cover Tape Designator Section Cavities Status Status Leader (Start End) 125 (typ) Sealed Empty L6X Carrier 5000 Filled Sealed Trailer (Hub End) 75 (typ) Empty Sealed TAPE DIMENSIONS inches (millimeters) 1.75±0.10 3.50±0.05 8.00 +0.30 ø 0.50 ±0.05 SECTION B-B SCALE:10X DIRECTION OF FEED-0.254±0.020 C 0.70±0.05 SECTION A-A SCALE:10X REEL DIMENSIONS inches (millimeters) TAPE SLOT DETAIL X DETAIL X SCALE: 3X W1 Tape В С D N W2 W3 0.331 + 0.059/-0.000 W1 + 0.078/-0.039 7.0 0.059 0.512 0.795 2.165 0.567 8 mm (177.8)(1.50)(13.00)(20.20)(55.00)(8.40 + 1.50/-0.00)(14.40)(W1 + 2.00/-1.00)

Physical Dimensions inches (millimeters) unless otherwise noted



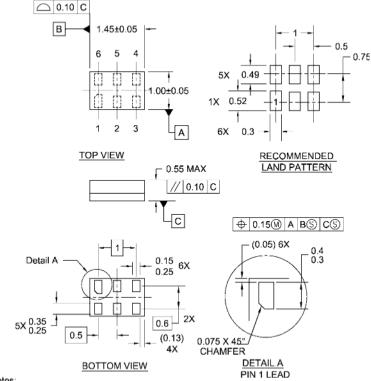
NOTES:

- A. CONFORMS TO EIAJ REGISTERED OUTLINE DRAWING SC88. B. DIMENSIONS DO NOT INCLUDE BURRS OR MOLD FLASH.
- C. DIMENSIONS ARE IN MILLIMETERS.

MAA06ARevC

6-Lead SC70, EIAJ SC88, 1.25mm Wide Package Number MAA06A

Physical Dimensions inches (millimeters) unless otherwise noted (Continued)



- Notes:
- 1. JEDEC PACKAGE REGISTRATION IS ANTICIPATED
- 2. DIMENSIONS ARE IN MILLIMETERS
- 3. DRAWING CONFORMS TO ASME Y14.5M-1994

MAC06ARevB

6-Lead MicroPak, 1.0mm Wide Package Number MAC06A

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